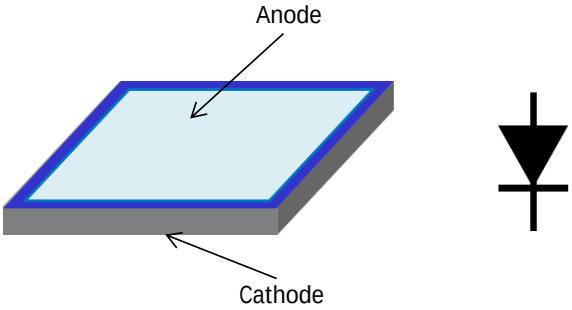
YJ Planar Fast Recovery Diode Die Specification

400V 60A, Fast recovery diode die based on silicon planar process
Part No.: FRD60A400AS-290A



Main Products Characterstics

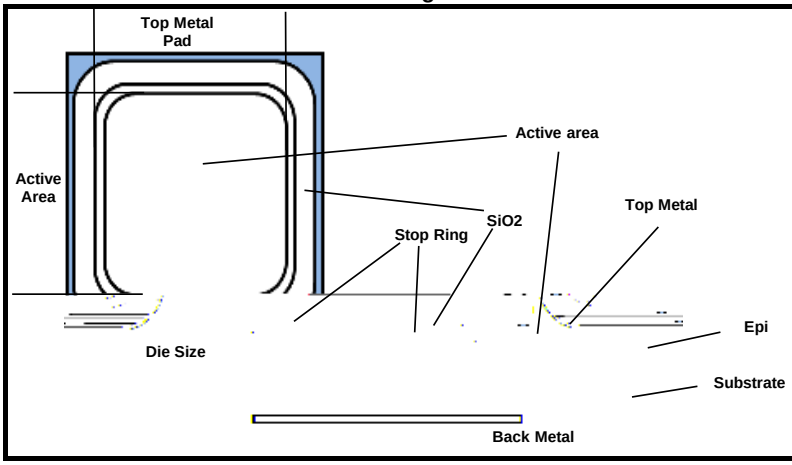
Maximum Ratings

Parameter	Symbol	Rating
Repetitive peak reverse voltage	V_{RRM}	400V
Average forward current	$I_{F(AV)}$	60A
(tp = 8.3 ms, halfwave, 1 cycle)	I_{FSM}	500A
Storage temperature range	T_{stg}	-40 to +150 °C
Maximum operating junction temperature	T_j	150 °C

Static Electrical Characteristics (Ta = 25°C)

Parameter	Symbol	Value	
		Spec	Typical
Reverse breakdown voltage I_R = 50uA	V_{BR}	420V	440V
Maximum forward voltage drop I_F 2%	V_F	1.15V	1.05V
Reverse Recovery Time I_F=0.5A, I_R=1A, I_{rr}=0.25A	Trr	75ns	65ns
Maximum reverse current $V_R = V_{RRM}$ 2%	I_R	2uA	0.05uA

Device Schematics and Outline Drawing



Die Thickness	290um
Die Size *	5800x5800um
Top Metal Pad	5070x5070um
Active Area	5012x5012um
Top Metal	Al
Back Metal	Ag

Note: 1 *: Cutting street width is around 40um

Important Notice

Specification apply to die only. Actual performance may degrade when assembled.

Yangjie Electronics does not guarantee device performance after assembly.
All operating parameters must be validated for each customer application by customer's technical experts.

Data sheet information is subjected to change without notice.

Recommended Storage Environment:

Store in original container, in dessicated nitrogen, with no contamination.

Shelf life for parts stored in above condition is 2 years.

If the storage is done in normal atmosphere shelf life is reduced to 6 months.